

## Power Bridge Rectifiers

## **DBI 25**

## **Features**

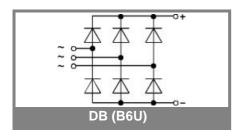
- Isolated metal case with in-line wire leads
- · Ideal for printed circuit boards
- · Allow easy heatsink mounting
- Solder temperature: 260 °C max. (max 5 s)
- Blocking voltage up to 1600 V
- · High surge current
- Standard packing: 54 pieces box

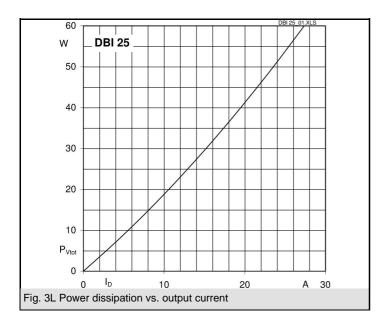
## **Typical Applications\***

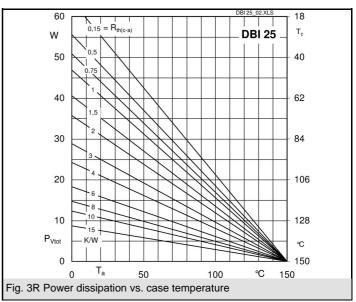
- Rectifier for power supplies
- Input rectifier for variable frequency drives
- Rectifier for DC motor field supplies
- Battery charger rectifiers
- Recommended snubber network: RC: 50  $\Omega$ , 0.1  $\mu$ F (P  $_{R}$  = 1 W)
- 1) Mounted on a 50 x 75 mm p.c.b.
- 2) Mounted on a painted metal sheet of min. 250 x 250 x 1 mm
- 3) Recommended  $V_{VRMS}$  values:  $V_{VRMS} = V_{RRM} / 2,83$

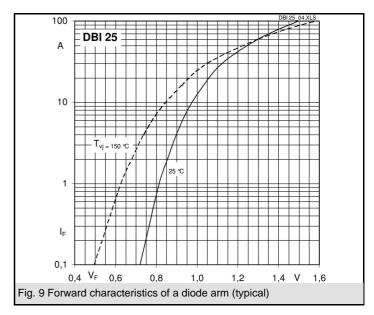
$V_{RSM}, V_{RRM}$	V <sub>VRMS</sub>	$I_D = 25 \text{ A } (T_c = 32 \text{ °C})$	C <sub>max</sub>	$R_{min}$
V	V	Types	μF	Ω
200	140	DBI 25-02		0,15
400	280	DBI 25-04		0,3
800	560	DBI 25-08		0,7
1200	800	DBI 25-12		1
1600	1000	DBI 25-16		1,5

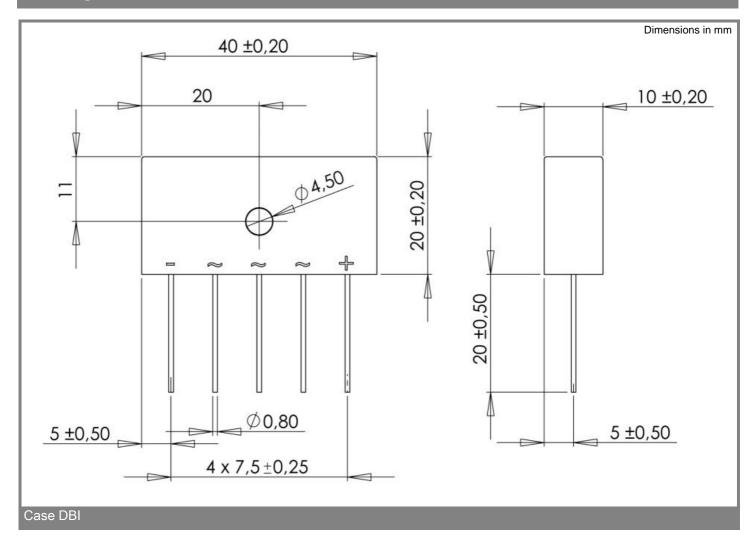
Symbol	Conditions	Values	Units
I <sub>D</sub>	T <sub>a</sub> = 46 °C, P1/120, natural cooling	17	Α
_	T <sub>a</sub> = 46 °C, chassis <sup>2)</sup>	11	Α
I <sub>DCL</sub>	T <sub>a</sub> = 46 °C, P1/120, natural cooling	17	Α
	T <sub>a</sub> = 46 °C, chassis <sup>2)</sup>	11	Α
	T <sub>a</sub> = 45 °C, isolated <sup>1)</sup>	2,9	Α
I <sub>FSM</sub>	T <sub>vi</sub> = 25 °C, 10 ms	370	Α
	T <sub>vj</sub> = 150 °C, 10 ms	310	Α
i²t	T <sub>vj</sub> = 25 °C, 8,3 10 ms	680	A²s
	T <sub>vj</sub> = 150 °C, 8,3 10 ms	480	A²s
V <sub>F</sub>	T <sub>vj</sub> = 25°C, I <sub>F</sub> = 12,5 A	max. 1,05	V
$V_{(TO)}$	T <sub>vj</sub> = 150°C	max. 0,85	V
r <sub>T</sub>	T <sub>vj</sub> = 150°C	max. 9	mΩ
$I_{RD}$	$T_{vj} = 25^{\circ}C, V_{RD} = V_{RRM}$	50	μA
	$T_{vi} = {^{\circ}C}, V_{RD} = V_{RRM} \ge V$		μA
$I_{RD}$	$T_{vi} = 150$ °C, $V_{RD} = V_{RRM}$	5	mA
	$T_{vj} = {^{\circ}C}, V_{RD} = V_{RRM} \ge V$		mA
t <sub>rr</sub>	$T_{vj} = 25^{\circ}C$	10	μs
$f_G$		2000	Hz
R <sub>th(j-a)</sub>	isolated <sup>1)</sup>	21	K/W
() 2.7	chassis <sup>2)</sup>	5	K/W
R <sub>th(j-c)</sub>	total (from junctions to bridge back side)	2,2	K/W
R <sub>th(c-s)</sub>	total	0,15	K/W
T <sub>vi</sub>		- 40 <b>+</b> 150	°C
T <sub>stg</sub>		- 55 <b>+</b> 150	°C
V <sub>isol</sub>	a.c. 5060 Hz; r.m.s.; 1s / 1 min.	3000 / 2500	V~
M <sub>s</sub>	torque for heatsink mounting (M4 screw)	2 ± 15 %	Nm
M <sub>t</sub>			Nm
a			m/s²
w	approx.	21	g
Fu			А
Case	40 x 20 x 10 mm plus leads = 20 mm	DBI	











<sup>\*</sup> The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.